











PCM3070

SLAS724A - SEPTEMBER 2008 - REVISED NOVEMBER 2014

PCM3070 Stereo Audio Codec With Embedded miniDSP

Features

- Stereo Audio DAC with 100dB SNR
- Stereo Audio ADC with 93dB SNR
- Extensive Signal Processing Options
- Embedded miniDSP
- Six Single-Ended or 3 Fully-Differential Analog Inputs
- Stereo Headphone Outputs
- Stereo Line Outputs
- Very Low-Noise PGA
- Analog Bypass Mode
- Programmable PLL
- Integrated LDO
- 5 mm x 5 mm 32-Pin QFN Package

2 Applications

- Soundbar
- Flat Panel Television
- MP3 Docking stations
- Cell Phone Docking Stations
- Other Stereo or 2.1 Home Audio systems

Description

The PCM3070 is a flexible stereo audio codec with programmable inputs and outputs, programmable miniDSP, fixed predefined and parameterizable signal processing blocks, integrated PLL, integrated LDOs and flexible digital interfaces.

Device Information⁽¹⁾

PART NUMBER	PACKAGE	BODY SIZE (NOM)
PCM3070	VQFN (32)	5.00 mm x 5.00 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.

Simplified Schematic

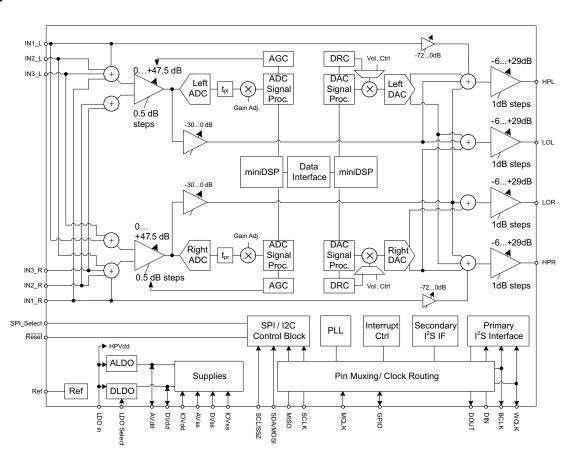




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5 Revision History

Changes from Original (February 2011) to Revision A

Page

Added Pin Configuration and Functions section, Handling Rating table, Feature Description section, Device
Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout
section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information
section

Product Folder Links: PCM3070

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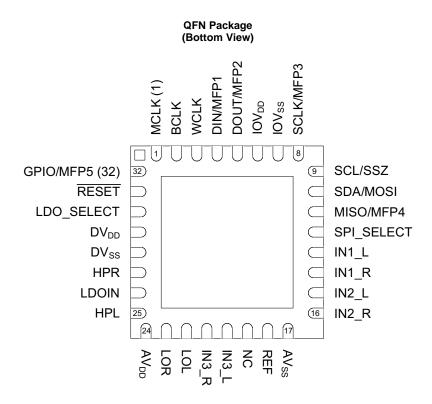
6 Device Comparison Table

PART NUMBER	DESCRIPTION
PCM3070	Stereo audio codec with embedded miniDSP



7 Pin Configuration and Functions

This document describes signals that take on different names depending on how they are configured. In such cases, the different names are placed together and separated by slash (/) characters. For example, "SCL/SS". Active low signals are represented by overbars.



Pin Functions

PIN	NAME	TYPE ⁽¹⁾	DESCRIPTION
1	MCLK	DI	Master Clock Input
2	BCLK	DIO	Audio serial data bus (primary) bit clock
3	WCLK	DIO	Audio serial data bus (primary) word clock
4	DIN	DI	Primary function:
			Audio serial data bus data input
	MFP1		Secondary function:
			General Purpose Clock Input
			General Purpose Input
5	DOUT	DO	Primary function:
			Audio serial data bus data output
	MFP2		Secondary function:
			General Purpose Output
			Clock Output
			INT1 Output
			INT2 Output Audio serial data bus (secondary) bit clock output
			Audio serial data bus (secondary) bit clock output Audio serial data bus (secondary) word clock output
6	IOV _{DD}	Power	IO voltage supply 1.1V – 3.6V
7	IOV _{SS}	Ground	IO ground supply

(1) DI (Digital Input), DO (Digital Output), DIO (Digital Input/Output), AI (Analog Input), AO (Analog Output), AIO (Analog Input/Output)



Pin Functions (continued)

PIN	NAME	TYPE ⁽¹⁾	DESCRIPTION
8	SCLK	DI	Primary function: (SPI_Select = 1)
	/		SPI serial clock
	MFP3		Secondary function: (SPI_Select = 0)
			Audio serial data bus (secondary) bit clock input Audio serial data bus (secondary) DAC or common word clock input Audio serial data bus (secondary) ADC word clock input Audio serial data bus (secondary) data input General Purpose Input
9	SCL/SS	DI	I ² C interface serial clock (SPI_Select = 0) SPI interface mode chip-select signal (SPI_Select = 1)
10	SDA/MOSI	DI	I ² C interface mode serial data input (SPI_Select = 0) SPI interface mode serial data input (SPI_Select = 1)
11	MISO	DO	Primary function: (SPI_Select = 1)
	/		Serial data output
	MFP4		Secondary function: (SPI_Select = 0)
			General purpose output CLKOUT output INT1 output INT2 output Audio serial data bus (primary) ADC word clock output Audio serial data bus (secondary) data output Audio serial data bus (secondary) bit clock output Audio serial data bus (secondary) word clock output Audio serial data bus (secondary) word clock output
12	SPI_ SELECT	DI	Control mode select pin (1 = SPI, $0 = I^2C$)
13	IN1_L	AI	Multifunction Analog Input, or Single-ended configuration: Line 1 left or Differential configuration: Line right, negative
14	IN1_R	AI	Multifunction Analog Input, or Single-ended configuration: or Line 1 right or Differential configuration: Line right, positive
15	IN2_L	Al	Multifunction Analog Input, or Single-ended configuration: Line 2 left or Differential configuration: Line left, positive
16	IN2_R	AI	Multifunction Analog Input, or Single-ended configuration: Line 2 right or Differential configuration: Line left, negative
17	AV _{SS}	Ground	Analog ground supply
18	REF	AO	Reference voltage output for filtering
19	NC		NC, do not connect
20	IN3_L	AI	Multifunction Analog Input, or Single-ended configuration: Line 3 left, or Differential configuration: Line left, positive, or Differential configuration: Line right, negative
21	IN3_R	AI	Multifunction Analog Input, or Single-ended configuration: Line 3 right, or Differential configuration: Line left, negative, or Differential configuration: Line right, positive
22	LOL	AO	Left line output
23	LOR	AO	Right line output
24	AV _{DD}	Power	Analog voltage supply 1.5V–1.95V Input when A-LDO disabled, Filtering output when A-LDO enabled
25	HPL	AO	Left high power output driver
26	LDOIN/HPVDD	Power	LDO Input supply and Headphone Power supply 1.9V- 3.6V



Pin Functions (continued)

PIN	NAME	TYPE ⁽¹⁾	DESCRIPTION
27	HPR	AO	Right high power output driver
28	DV _{SS}	Ground	Digital Ground and Chip-substrate
29	DV_DD	Power	If LDO_SELECT Pin = 0 (D-LDO disabled)
			Digital voltage supply 1.26V – 1.95V
			If LDO_SELECT Pin = 1 (D-LDO enabled)
			Digital voltage supply filtering output
30	LDO_ SELECT	DI	D-LDO enable signal (1 = D-LDO enable, 0 = D-LDO disabled)
31	RESET	DI	Reset (active low)
32	GPIO	DI	Primary function:
			General Purpose digital IO
	MFP5		Secondary function:
			CLKOUT Output
			INT1 Output
			INT2 Output
			Audio serial data bus ADC word clock output
			Audio serial data bus (secondary) bit clock output
			Audio serial data bus (secondary) word clock output
Thermal Pad	Thermal Pad	N/A	Connect to PCB ground plane. Not internally connected.

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8 Specifications

8.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

		MIN	MAX	UNIT
	AV _{DD} to AV _{SS}	-0.3	2.2	V
Input voltage	DV _{DD} to DV _{SS}	-0.3	2.2	V
	IOV _{DD} to IOV _{SS}	-0.3	3.9	٧
	LDOIN to AV _{SS}	-0.3	3.9	٧
Digital Input voltage	Digital Input voltage		$IOV_{DD} + 0.3$	٧
Analog input voltage	nalog input voltage		$AV_{DD} + 0.3$	٧
Operating temperature ran	perating temperature range		85	ô
Junction temperature (T _J N	Max)		105	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

8.2 Handling Ratings

			MIN	MAX	UNIT
T _{stg}	Storage temperature	range	-55	125	°C
	Flootroototio	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins (1)	-2	2	kV
V _(ESD)	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	-750	750	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

8.3 Recommended Operating Conditions

	. 5		MIN	NOM	MAX	UNIT	
LDOIN		Referenced to AV _{SS} ⁽¹⁾	1.9		3.6		
AV_{DD}	, ,	Referenced to AV _{SS} */	1.5	1.8	1.95	V	
IOV_{DD}	Power Supply Voltage Range	Referenced to IOV _{SS} ⁽¹⁾	1.5		3.6	v	
DV _{DD} ⁽²⁾		Referenced to DV _{SS} ⁽¹⁾		1.8	1.95		
	DL Input Fraguency	Clock divider uses fractional divide $(D > 0)$, $P = 1$, $DV_{DD} \ge 1.65V$	10		20	MHz	
PLL Input Frequency		Clock divider uses integer divide (D = 0), P = 1, DV _{DD} ≥ 1.65V	0.512		20	MHz	
MCLK	Master Clark Fragueses	MCLK; Master Clock Frequency; DV _{DD} ≥ 1.65V			50	MHz	
IVICLK	Master Clock Frequency	MCLK; Master Clock Frequency; DV _{DD} ≥ 1.26V			25	IVITZ	
SCL	SCL Clock Frequency				400	kHz	
	Audio input max ac signal swing	CM = 0.75 V	0	0.530	0.75 or AVDD-0.75 ⁽³⁾	Vpeak	
	(IN1_L, IN1_R, IN2_L, IN2_R, IN3_L, IN3_R)	CM = 0.9 V	0	0.707	0.9 or AVDD-0.9 ⁽³⁾	Vpeak	
C _{Lout}	Digital output load capacitance			10		pF	
T _{OPR}	Operating Temperature Range		-40		85	°C	

⁽¹⁾ All grounds on board are tied together to prevent voltage differences of more than 0.2V maximum for any combination of ground signals.

(3) Whichever is smaller.

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

⁽²⁾ At DV_{DD} values lower than 1.65V, the PLL does not function. Refer to the Maximum PCM3070 Clock Fréquencies table in the PCM3070 Application Reference Guide (SLAU332) for details on maximum clock frequencies.



8.4 Thermal Information

		PCM3070	
	THERMAL METRIC ⁽¹⁾	RHB (QFN)	UNIT
		32 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	31.4	
$R_{\theta JCtop}$	Junction-to-case (top) thermal resistance	21.4	
$R_{\theta JB}$	Junction-to-board thermal resistance	5.4	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.2	C/VV
ΨЈВ	Junction-to-board characterization parameter	5.4	
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance	0.9	

⁽¹⁾ For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

8.5 Electrical Characteristics, ADC

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
AUDIO A	DC					
	Input signal level (0dB)	Single-ended, CM = 0.9V		0.5		V_{RMS}
	Device Setup	1kHz sine wave input , Single-ended Configuration IN1_R to Right ADC and IN1_L to Left ADC, $R_{in} = 20K, f_s = 48kHz, \\ AOSR = 128, MCLK = 256 \times f_s, \\ PLL Disabled; AGC = OFF, Channel Gain = 0dB, \\ Processing Block = PRB_R1, \\$				
		Inputs ac-shorted to ground	80	93		
SNR	Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾	IN2_R, IN3_R routed to Right ADC and ac-shorted to ground IN2_L, IN3_L routed to Left ADC and ac-shorted to ground		93		dB
DR	Dynamic range A-weighted ⁽¹⁾⁽²⁾	-60dB full-scale, 1-kHz input signal		92		dB
		-3 dB full-scale, 1-kHz input signal		-85	-70	
THD+N	Total Harmonic Distortion plus Noise	IN2_R, IN3_R routed to Right ADC IN2_L, IN3_L routed to Left ADC -3dB full-scale, 1-kHz input signal		-85		dB
AUDIO A	DC					
	Input signal level (0dB)	Single-ended, CM = 0.75V, AV _{DD} = 1.5V		0.375		V_{RMS}
	Device Setup	1kHz sine wave input, Single-ended Configuration IN1_R, IN2_R, IN3_R routed to Right ADC IN1_L, IN2_L, IN3_L routed to Left ADC $R_{in} = 20k\Omega, f_s = 48kHz, \\ AOSR = 128, MCLK = 256 \times f_s, \\ PLL Disabled, AGC = OFF, Channel Gain = 0dB, \\ Processing Block = PRB_R1$				
SNR	Signal-to-noise ratio, A-weighted (1)(2)	Inputs ac-shorted to ground		91		dB
DR	Dynamic range A-weighted ⁽¹⁾⁽²⁾	-60dB full-scale, 1-kHz input signal		90		dB
THD+N	Total Harmonic Distortion plus Noise	-3dB full-scale, 1-kHz input signal		-80		dB

⁽¹⁾ Ratio of output level with 1kHz full-scale sine wave input, to the output level with the inputs short circuited, measured A-weighted over a 20Hz to 20kHz bandwidth using an audio analyzer.

⁽²⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Failure to use such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values.



Electrical Characteristics, ADC (continued)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
AUDIO	ADC					
	Input signal level (0dB)	Differential Input, CM = 0.9V		10		mV
	Device Setup	1kHz sine wave input, Differential configuration IN1_L and IN1_R routed to Right ADC IN2_L and IN2_R routed to Left ADC R _{in} = 10K, f _s = 48kHz, AOSR = 128 MCLK = 256* f _s PLL Disabled AGC = OFF, Channel Gain = 40dB Processing Block = PRB_R1,				
ICN	Idle-Channel Noise, A-weighted (1)(2)	Inputs ac-shorted to ground, input referred noise		2		μV_{RMS}
AUDIO	ADC		1		,	
	Gain Error	$ \begin{array}{l} 1 \text{kHz sine wave input , Single-ended configuration} \\ R_{\text{in}} = 20 \text{k}\Omega f_{\text{s}} = 48 \text{kHz, AOSR} = 128, \\ \text{MCLK} = 256 \times f_{\text{s}}, \text{PLL Disabled} \\ \text{AGC} = \text{OFF, Channel Gain} = 0 \text{dB} \\ \text{Processing Block} = \text{PRB_R1}, \\ \end{array} $		-0.05		dB
	Input Channel Separation	1kHz sine wave input at -3dBFS Single-ended configuration IN1_L routed to Left ADC IN1_R routed to Right ADC, R _{in} = 20kΩ AGC = OFF, AOSR = 128, Channel Gain = 0dB, CM = 0.9V		108		dB
	Input Pin Crosstalk	1kHz sine wave input at –3dBFS on IN2_L, IN2_L internally not routed. IN1_L routed to Left ADC ac-coupled to ground 1kHz sine wave input at –3dBFS on IN2_R, IN2_R internally not routed. IN1_R routed to Right ADC ac-coupled to ground		115		dB
		Single-ended configuration $R_{in}=20k\Omega,$ AOSR = 128 Channel, Gain = 0dB, CM = 0.9V				
	PSRR	217Hz, 100mVpp signal on AV_{DD} , Single-ended configuration, $R_{in}=20k\Omega$, Channel Gain = 0dB; $CM=0.9V$		55		dB
		Single-Ended, $R_{in} = 10k\Omega$, PGA gain set to 0dB		0		dB
		Single-Ended, $R_{in} = 10k\Omega$, PGA gain set to 47.5dB		47.5		dB
	ADC programmable gain amplifier	Single-Ended, $R_{in} = 20k\Omega$, PGA gain set to 0dB		-6		dB
	gain	Single-Ended, $R_{in} = 20k\Omega$, PGA gain set to 47.5dB		41.5		dB
		Single-Ended, $R_{in} = 40k\Omega$, PGA gain set to 0dB		-12		dB
		Single-Ended, $R_{in} = 40k\Omega$, PGA gain set to 47.5dB		35.5		dB
	ADC programmable gain amplifier step size	1-kHz tone		0.5		dB



8.6 Electrical Characteristics, Bypass Outputs

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
ANAL	OG BYPASS TO HEADPHONE AMPLIFIER	, DIRECT MODE				
	Device Setup	Load = 16Ω (single-ended), 50pF; Input and Output CM = 0.9V; Headphone Output on LDOIN Supply; IN1_L routed to HPL and IN1_R routed to HPR; Channel Gain = 0dB				
	Gain Error			-0.8		dB
Noise, A-weighted ⁽¹⁾ Idle Chanr ground		Idle Channel, IN1_L and IN1_R ac-shorted to ground		3		μV_{RMS}
THD	Total Harmonic Distortion	446mVrms, 1kHz input signal		-89		dB
ANAL	OG BYPASS TO LINE-OUT AMPLIFIER, PO	GA MODE			*	
Device Setup		Load = $10k\Omega$ (single-ended), $56pF$; Input and Output CM = $0.9V$; LINE Output on LDOIN Supply; IN1_L routed to ADCPGA_L and IN1_R routed to ADCPGA_R; $R_{in} = 20k\Omega$ ADCPGA_L routed to LOL and ADCPGA_R routed to LOR; Channel Gain = $0dB$				
	Gain Error			0.6		dB
		Idle Channel, IN1_L and IN1_R ac-shorted to ground		7		μV_{RMS}
	Noise, A-weighted ⁽¹⁾	Channel Gain = 40dB, Input Signal (0dB) = 5mV _{rms} Inputs ac-shorted to ground, Input Referred		3.4		μV_{RMS}

⁽¹⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Testing without such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values.



8.7 Electrical Characteristics, Audio DAC Outputs

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
AUDIO I	DAC – STEREO SINGLE-ENDED LINE O	UTPUT				
	Device Setup	Load = $10k\Omega$ (single-ended), $56pF$ Line Output on AV_{DD} Supply Input and Output CM = $0.9V$ DOSR = 128 , MCLK = 256 x f_s , Channel Gain = $0dB$, word length = 16 bits, Processing Block = PRB_P1 ,				
	Full scale output voltage (0dB)			0.5		V_{RMS}
SNR	Signal-to-noise ratio A-weighted ⁽¹⁾⁽²⁾	All zeros fed to DAC input	87	100		dB
DR	Dynamic range, A-weighted (1)(2)	-60dB 1kHz input full-scale signal, Word length = 20 bits		100		dB
THD+N	Total Harmonic Distortion plus Noise	-3dB full-scale, 1kHz input signal		-83	-70	dB
	DAC Gain Error	0 dB, 1kHz input full scale signal		0.3		dB
	DAC Mute Attenuation	Mute		119		dB
	DAC channel separation	-1 dB, 1kHz signal, between left and right HP out		113		dB
	DAC PSRR	100mVpp, 1kHz signal applied to AV _{DD}		73		dB
	DACFSKK	100mVpp, 217Hz signal applied to AV _{DD}		77		dB
AUDIO [DAC – STEREO SINGLE-ENDED LINE O	UTPUT			·	
	Device Setup	Load = $10k\Omega$ (single-ended), 56pF Line Output on AV_{DD} Supply Input and Output CM = $0.75V$; AV_{DD} = $1.5V$ DOSR = 128 MCLK = $256 * fs$ Channel Gain = $-2dB$ word length = 20 bits Processing Block = PRB_P1				
	Full scale output voltage (0dB)			0.375		V_{RMS}
SNR	Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾	All zeros fed to DAC input		99		dB
DR	Dynamic range, A-weighted (1)(2)	-60dB 1 kHz input full-scale signal		97		dB
THD+N	Total Harmonic Distortion plus Noise	-1 dB full-scale, 1-kHz input signal		-85		dB
AUDIO I	DAC – STEREO SINGLE-ENDED HEADF	PHONE OUTPUT				
	Device Setup	Load = 16Ω (single-ended), $50pF$ Headphone Output on AV_{DD} Supply, Input and Output CM = $0.9V$, DOSR = 128 , MCLK = $256 * f_s$, Channel Gain = $0dB$ word length = 16 bits; Processing Block = PRB_P1				
	Full scale output voltage (0dB)			0.5		V_{RMS}
SNR	Signal-to-noise ratio, A-weighted ⁽¹⁾⁽²⁾	All zeros fed to DAC input	87	100		dB
DR	Dynamic range, A-weighted (1)(2)	-60dB 1kHz input full-scale signal, Word Length = 20 bits		99		dB
THD+N	Total Harmonic Distortion plus Noise	-3dB full-scale, 1kHz input signal		-83	-70	dB
	DAC Gain Error	0dB, 1kHz input full scale signal		-0.3		dB
	DAC Mute Attenuation	Mute		122		dB
	DAC channel separation	-1dB, 1kHz signal, between left and right HP out		110		dB
	DAC PSRR	100mVpp, 1kHz signal applied to AV _{DD}		73		dB
	D. CO I OICE	100mVpp, 217Hz signal applied to AV _{DD}		78		dB

⁽¹⁾ Ratio of output level with 1kHz full-scale sine wave input, to the output level with the inputs short circuited, measured A-weighted over a 20Hz to 20kHz bandwidth using an audio analyzer.

⁽²⁾ All performance measured with 20kHz low-pass filter and, where noted, A-weighted filter. Testing without such a filter may result in higher THD+N and lower SNR and dynamic range readings than shown in the Electrical Characteristics. The low-pass filter removes out-of-band noise, which, although not audible, may affect dynamic specification values



Electrical Characteristics, Audio DAC Outputs (continued)

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
	Power Delivered	$R_L = 16\Omega$, Output Stage on $AV_{DD} = 1.8V$ THDN < 1%, Input CM = 0.9V, Output CM = 0.9V	15		mW
	Power Delivered	$R_L = 16\Omega$ Output Stage on LDOIN = 3.3V, THDN < 1% Input CM = 0.9V, Output CM = 1.65V	64		IIIVV
AUDIO	DAC – STEREO SINGLE-ENDED HEADP	PHONE OUTPUT			
	Device Setup	Load = 16Ω (single-ended), $50pF$, Headphone Output on AV_{DD} Supply, Input and Output CM = $0.75V$; $AV_{DD} = 1.5V$, DOSR = 128 , MCLK = $256 * f_s$, Channel Gain = $-2dB$, word length = 20 -bits; Processing Block = PRB_P1 ,			
	Full scale output voltage (0dB)		0.375		V_{RMS}
SNR	Signal-to-noise ratio, A-weighted (1)(2)	All zeros fed to DAC input	99		dB
DR	Dynamic range, A-weighted (1)(2)	-60dB 1kHz input full-scale signal	98		dB
THD+N	Total Harmonic Distortion plus Noise	-1dB full-scale, 1kHz input signal	-83		dB
AUDIO	DAC – MONO DIFFERENTIAL HEADPHO	ONE OUTPUT			
	Device Setup	Load = 32Ω (differential), 50pF, Headphone Output on LDOIN Supply Input CM = 0.75V, Output CM = 1.5V, AV _{DD} = 1.8V, LDOIN = 3.0V, DOSR = 128 MCLK = 256 * f _s , Channel (headphone driver) Gain = 5dB for full scale output signal, word length = 16 bits, Processing Block = PRB_P1,			
	Full scale output voltage (0dB)		1778		mV_{RMS}
SNR	Signal-to-noise ratio, A-weighted (1)(2)	All zeros fed to DAC input	98		dB
DR	Dynamic range, A-weighted (1)(2)	-60dB 1kHz input full-scale signal	96		dB
THD	Total Harmonic Distortion	-3dB full-scale, 1kHz input signal	-82		dB
	Power Delivered	$R_L = 32\Omega$, Output Stage on LDOIN = 3.3V, THDN < 1%, Input CM = 0.9V, Output CM = 1.65V	136		mW
	rowei Deliverea	$R_L = 32\Omega$ Output Stage on LDOIN = 3.0V, THDN < 1% Input CM = 0.9V, Output CM = 1.5V	114		mW



8.8 Electrical Characteristics, LDO

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
LOW DROPOUT REGULATOR (AVdd)					
	LDOMode = 1, LDOIN > 1.95V		1.67		
Output Voltage	LDOMode = 0, LDOIN > 2.0V		1.72		V
	LDOMode = 2, LDOIN > 2.05V		1.77		
Output Voltage Accuracy			±2%		
Load Regulation	Load current range 0 to 50mA		15		mV
Line Regulation	Input Supply Range 1.9V to 3.6V		5		mV
Decoupling Capacitor		1			μF
Bias Current			60		μΑ

8.9 Electrical Characteristics, Misc.

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
REFERENCE					
Deference Voltage Cettings	CMMode = 0 (0.9V)		0.9		V
Reference Voltage Settings	CMMode = 1 (0.75V)		0.75		V
Reference Noise	CM = 0.9V, A-weighted, 20Hz to 20kHz bandwidth, $C_{\rm ref} = 10 \mu F$		1		μV_{RfcMS}
Decoupling Capacitor		1	10		μF
miniDSP ⁽¹⁾					
Maximum miniDSP clock frequency - ADC	DV _{DD} = 1.65V		55.3		MHz
Maximum miniDSP clock frequency - DAC	DV _{DD} = 1.65V		55.3		MHz
Shutdown Current					
Device Setup	Coarse AVdd supply turned off, LDO_select held at ground, No external digital input is toggled				
I(DV _{DD})			0.9		μA
I(IOVDD)			13		nA

⁽¹⁾ miniDSP clock speed is specified by design and not tested in production.

8.10 Electrical Characteristics, Logic Levels (1)

At 25°C, AV_{DD} , DV_{DD} , $IOV_{DD} = 1.8V$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT				
LOGIC FAMILY			CMOS						
	I _{IH} = 5 μA, IOV _{DD} > 1.6V	0.7 × IOV _{DD}			V				
V _{IH} Logic Level	$I_{IH} = 5\mu A, 1.2V \le IOV_{DD} < 1.6V$	0.9 × IOV _{DD}			V				
	$I_{IH} = 5\mu A$, $IOV_{DD} < 1.2V$	IOV _{DD}			V				
	I _{IL} = 5 μA, IOV _{DD} > 1.6V	-0.3	0.3	× IOV _{DD}	V				
V_{IL}	$I_{IL} = 5\mu A, 1.2V \le IOV_{DD} < 1.6V$		0.1	\times IOV _{DD}	V				
	$I_{IL} = 5\mu A$, $IOV_{DD} < 1.2V$			0	V				
V _{OH}	I _{OH} = 2 TTL loads	0.8 × IOV _{DD}			V				
V _{OL}	I _{OL} = 2 TTL loads		0.1	× IOV _{DD}	V				
Capacitive L	oad		10		pF				

(1) Applies to all DI, DO, and DIO pins shown in Pin Configuration and Functions.

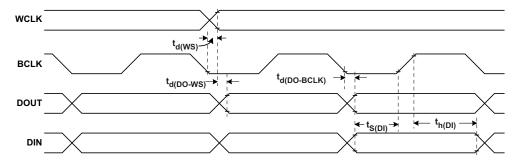
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8.11 I²S LJF and RJF Timing in Master Mode (see Figure 1)

		IOVDD = 1.8V	IOVDD = 3.3V	UNIT
		MIN MAX	MIN MAX	UNII
t _{d(WS)}	WCLK delay	30	20	ns
t _{d(DO-WS)}	WCLK to DOUT delay (For LJF Mode only)	20	20	ns
t _{d(DO-BCLK)}	BCLK to DOUT delay	22	20	ns
t _{s(DI)}	DIN setup	8	8	ns
t _{h(DI)}	DIN hold	8	8	ns
t _r	Rise time	24	12	ns
t _f	Fall time	24	12	ns



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8.12 I²S LJF and RJF Timing in Slave Mode (see Figure 2)

	, ,	IOVDD = 1	IOVDD = 1.8V		3.3V	UNIT
		MIN	MIN MAX		MIN MAX	
t _{H(BCLK)}	BCLK high period	35		35		ns
t _{L(BCLK)}	BCLK low period	35		35		ns
t _{s(WS)}	WCLK setup	8		8		ns
t _{h(WS)}	WCLK hold	8		8		ns
t _{d(DO-WS)}	WCLK to DOUT delay (For LJF mode only)		20		20	ns
$t_{d(DO\text{-BCLK})}$	BCLK to DOUT delay		22		22	ns
$t_{s(DI)}$	DIN setup	8		8		ns
$t_{h(DI)}$	DIN hold	8		8		ns
t _r	Rise time		4		4	ns
t _f	Fall time		4		4	ns

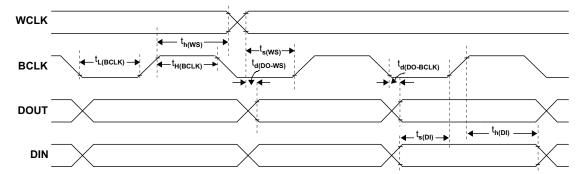
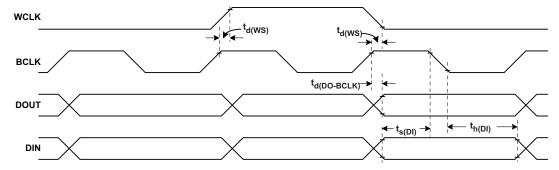


Figure 2. I²S LJF and RJF Timing in Slave Mode



8.13 DSP Timing in Master Mode (see Figure 3)

		IOVDD = 1.8V		IOVDD = 3.3V		UNIT
		MIN	MAX	MIN	MAX	
t _{d(WS)}	WCLK delay		30		20	ns
t _{d(DO-BCLK)}	BCLK to DOUT delay		22		20	ns
t _{s(DI)}	DIN setup	8		8		ns
t _{h(DI)}	DIN hold	8		8		ns
t _r	Rise time		24		12	ns
t _f	Fall time		24		12	ns



All specifications at 25°C, DVdd = 1.8V

Figure 3. DSP Timing in Master Mode



8.14 DSP Timing in Slave Mode (see Figure 4)

		IOVDD =	IOVDD = 1.8V		IOVDD = 3.3V	
		MIN	MAX	MIN	MAX	
t _{H(BCLK)}	BCLK high period	35		35		ns
t _{L(BCLK)}	BCLK low period	35		35		ns
t _{s(WS)}	WCLK setup	8		8		ns
t _{h(WS)}	WCLK hold	8		8		ns
t _{d(DO-BCLK)}	BCLK to DOUT delay		22		22	ns
t _{s(DI)}	DIN setup	8		8		ns
t _{h(DI)}	DIN hold	8		8		ns
t _r	Rise time		4		4	ns
t _f	Fall time		4		4	ns

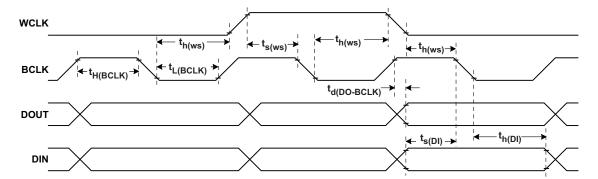


Figure 4. DSP Timing in Slave Mode



8.15 I²C Interface Timing

		Stand	dard-Mod	de	Fast		UNIT	
		MIN	TYP	MAX	MIN	TYP	MAX	
f _{SCL}	SCL clock frequency	0		100	0		400	kHz
t _{HD;STA}	Hold time (repeated) START condition. After this period, the first clock pulse is generated.	4.0			0.8			μs
t _{LOW}	LOW period of the SCL clock	4.7			1.3			μs
t _{HIGH}	HIGH period of the SCL clock	4.0			0.6			μs
t _{SU;STA}	Setup time for a repeated START condition	4.7			0.8			μs
t _{HD;DAT}	Data hold time: For I2C bus devices	0		3.45	0		0.9	μs
t _{SU;DAT}	Data set-up time	250			100			ns
t _r	SDA and SCL Rise Time			1000	20+0.1C _b		300	ns
t _f	SDA and SCL Fall Time			300	20+0.1C _b		300	ns
t _{SU;STO}	Set-up time for STOP condition	4.0			0.8			μs
t _{BUF}	Bus free time between a STOP and START condition	4.7			1.3			μs
C _b	Capacitive load for each bus line			400			400	pF

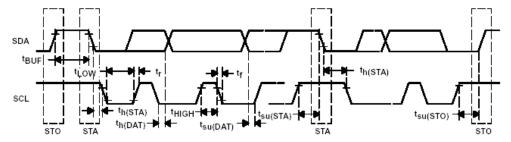


Figure 5. I²C Interface Timing



8.16 SPI Interface Timing (See Figure 6)

		IOVDD = 1.8V			IOVDD = 3.3V			UNIT
		MIN	TYP M	AX	MIN	TYP	MAX	
t _{sck}	SCLK Period ⁽¹⁾	100			50			ns
t _{sckh}	SCLK Pulse width High	50			25			ns
t _{sckl}	SCLK Pulse width Low	50			25			ns
t _{lead}	Enable Lead Time	30			20			ns
t _{trail}	Enable Trail Time	30			20			ns
t _{d;seqxfr}	Sequential Transfer Delay	40			20			ns
ta	Slave DOUT access time			40			20	ns
t _{dis}	Slave DOUT disable time			40			20	ns
t _{su}	DIN data setup time	15			10			ns
t _{h(DIN)}	DIN data hold time	15			10			ns
t _{v(DOUT)}	DOUT data valid time			25			18	ns
t _r	SCLK Rise Time			4			4	ns
t _f	SCLK Fall Time			4			4	ns

(1) These parameters are based on characterization and are not tested in production.

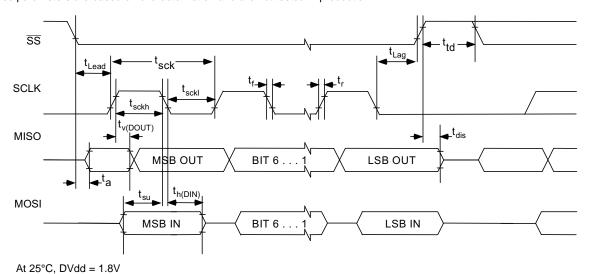
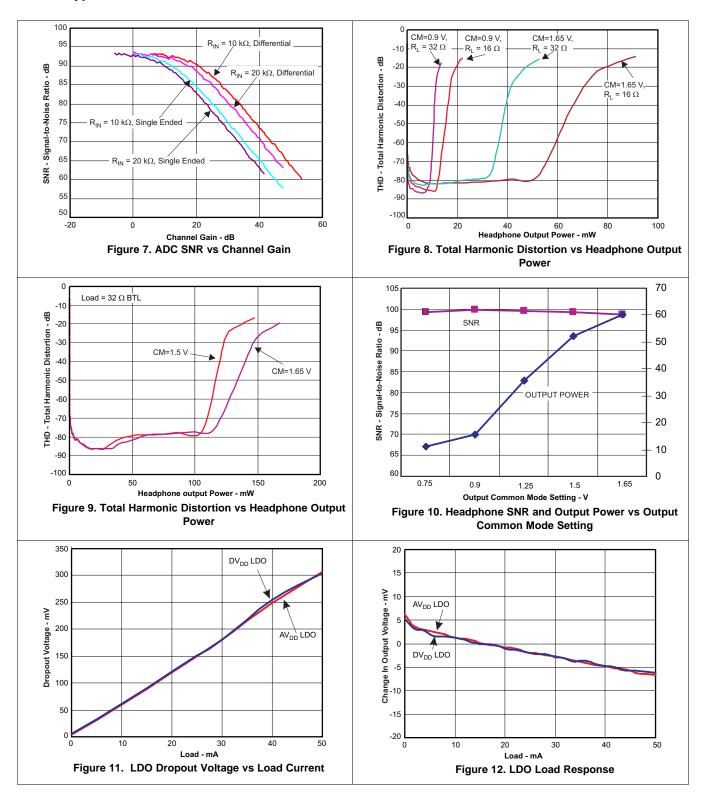


Figure 6. SPI Interface Timing Diagram



8.17 Typical Characteristics

8.17.1 Typical Performance

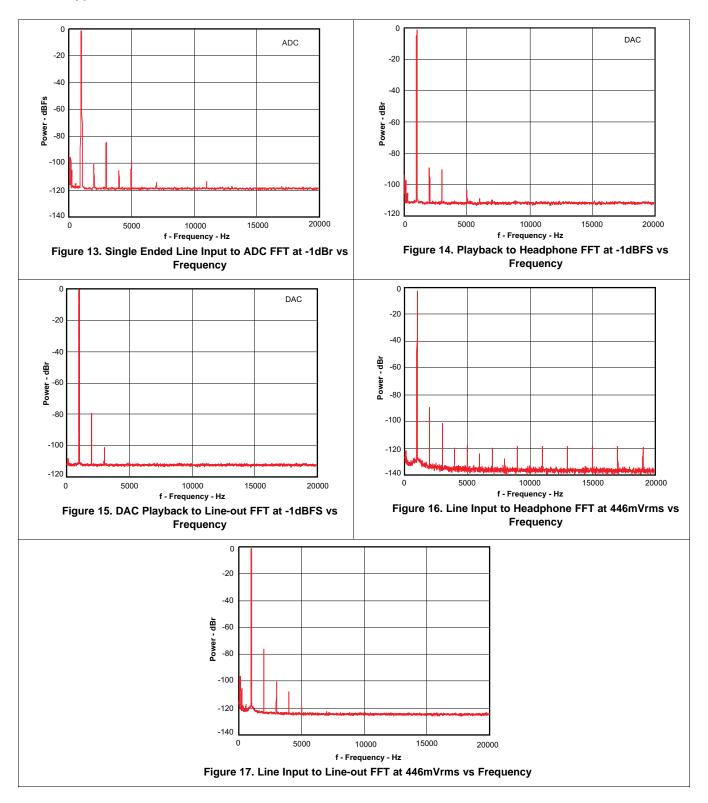


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8.17.2 Typical Characteristics, FFT





9 Parameter Measurement Information

All parameters are measured according to the conditions described in the *Specifications* section.

10 Detailed Description

10.1 Overview

The PCM3070 features two fully-programmable miniDSP cores that support application-specific algorithms in the record and/or the playback path of the device. The miniDSP cores are fully software controlled. Target algorithms, like speaker EQ, Crossovers, Dynamic Range Controls, Intelligent volume controls and other post-processing algorithms are loaded into the device after power-up.

Extensive register-based control of input/output channel configuration, gains, effects, pin-multiplexing and clocks is included, allowing the device to be precisely targeted to its application.

The record path of the PCM3070 covers operations from 8kHz mono to 192kHz stereo recording, and contains programmable input channel configurations covering single-ended and differential setups, as well as floating or mixed input signals.

The playback path offers signal-processing blocks for filtering and effects, and supports flexible mixing of DAC and analog input signals as well as programmable volume controls. The playback path contains two high-power output drivers as well as two fully-differential outputs. The high-power outputs can be configured in multiple ways, including stereo and mono BTL.

The voltage supply range for the PCM3070 for analog is 1.5V–1.95V, and for digital it is 1.26V–1.95V. To ease system-level design, LDOs are integrated to generate the appropriate analog or digital supply from input voltages ranging from 1.8V to 3.6V. Digital I/O voltages are supported in the range of 1.5V–3.6V.

The required internal clock of the PCM3070 can be derived from multiple sources, including the MCLK pin, the BCLK pin, the GPIO pin or the output of the internal PLL, where the input to the PLL again can be derived from the MCLK pin, the BCLK or GPIO pins. The PLL is highly programmable and can accept available input clocks in the range of 512kHz to 50MHz.



10.2 Functional Block Diagram

Figure 18 shows the basic functional blocks of the device.

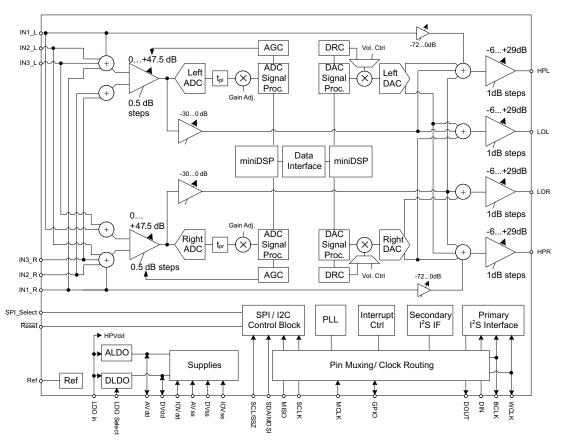


Figure 18. Block Diagram

10.3 Feature Description

10.3.1 Device Connections

10.3.1.1 Digital Pins

Only a small number of digital pins are dedicated to a single function; whenever possible, the digital pins have a default function, and also can be reprogrammed to cover alternative functions for various applications.

The fixed-function pins are Reset and the SPI_Select pin, which are HW control pins. Depending on the state of SPI_Select, the two control-bus pins SCL/SS and SDA/MOSI are configured for either I²C or SPI protocol.

Other digital IO pins can be configured for various functions via register control. An overview of available functionality is given in *Multifunction Pins*.



Feature Description (continued)

10.3.1.1.1 Multifunction Pins

Table 1 shows the possible allocation of pins for specific functions. The PLL input, for example, can be programmed to be any of 4 pins (MCLK, BCLK, DIN, GPIO).

Table 1. Multifunction Pin Assignments

		1	2	3	4	5	6	7	8
	Pin Function	MCLK	BCLK	WCLK	DIN MFP1	DOUT MFP2	MFP3/ SCLK	MFP4/ MISO	GPIO MFP5
Α	PLL Input	S ⁽¹⁾	S ⁽²⁾		E				S ⁽³⁾
В	Codec Clock Input	S ⁽¹⁾ ,D ⁽⁴⁾	S ⁽²⁾						S ⁽³⁾
С	I ² S BCLK input		S,D						
D	I ² S BCLK output		E ⁽⁵⁾						
E	I ² S WCLK input			E, D					
F	I ² S WCLK output			Е					
G	I ² S ADC word clock input						Е		Е
Н	I ² S ADC WCLK out							Е	Е
I	I ² S DIN				E, D				
J	I ² S DOUT					E, D			
K	General Purpose Output I					Е			
K	General Purpose Output II							Е	
K	General Purpose Output III								Е
L	General Purpose Input I				Е				
L	General Purpose Input II						Е		
L	General Purpose Input III								Е
М	INT1 output					Е		Е	Е
N	INT2 output					E		E	E
Q	Secondary I ² S BCLK input						E		Е
R	Secondary I ² S WCLK in						E		E
S	Secondary I ² S DIN						Е		Е
Т	Secondary I ² S DOUT							Е	
U	Secondary I ² S BCLK OUT					Е		Е	Е
٧	Secondary I ² S WCLK OUT					Е		Е	Е
W	Reserved								
X	Aux Clock Output					Е		Е	Е

⁽¹⁾ S⁽¹⁾: The MCLK pin can drive the PLL and Codec Clock inputs **simultaneously**.

10.3.1.2 Analog Pins

Analog functions can also be configured to a large degree. Analog blocks are powered down by default. The blocks can be powered up with fine granularity according to the application needs.

⁽²⁾ S⁽²⁾: The BCLK pin can drive the PLL and Codec Clock and audio interface bit clock inputs **simultaneously**.

⁽³⁾ S⁽³⁾: The GPIO/MFP5 pin can drive the PLL and Codec Clock inputs simultaneously.

⁽⁴⁾ D: Default Function

⁽⁵⁾ E: The pin is **exclusively** used for this function, no other function can be implemented with the same pin. (If GPIO/MFP5 has been allocated for General Purpose Output, it cannot be used as the INT1 output at the same time.)



10.3.2 Analog Audio I/O

The analog IO path of the PCM3070 features a large set of options for signal conditioning as well as signal routing:

- 6 analog inputs which can be mixed and-or multiplexed in single-ended and-or differential configuration
- 2 programmable gain amplifiers (PGA) with a range of 0 to +47.5dB
- · 2 mixer amplifiers for analog bypass
- · 2 low power analog bypass channels
- Mute function
- Automatic gain control (AGC)
- Channel-to-channel phase adjustment
- Fast charge of ac-coupling capacitors
- Anti thump

10.3.2.1 Analog Bypass

The PCM3070 offers two analog-bypass modes. In either of the modes, an analog input signal can be routed from an analog input pin to an amplifier driving an analog output pin. Neither the ADC nor the DAC resources are required for such operation.

In analog low-power bypass mode, line-level signals can be routed directly from the analog inputs INL to the left headphone amplifier (HPL) and INR to HPR.

10.3.2.2 ADC Bypass Using Mixer Amplifiers

In addition to the analog bypass mode, another bypass mode uses the programmable gain amplifiers of the input stage in conjunction with a mixer amplifier. With this mode, low-level signals can be amplified and routed to the line or headphone outputs, fully bypassing the ADC and DAC.

To enable this mode, the mixer amplifiers are powered on via software command.

10.3.2.3 Headphone Output

The stereo headphone drivers on pins HPL and HPR can drive loads with impedances down to 16Ω in single-ended AC-coupled headphone configurations, or loads down to 32Ω in differential mode, where a speaker is connected between HPL and HPR. In single-ended drive configuration these drivers can drive up to 15 mW power into each headphone channel while operating from 1.8 V analog supplies. While running from the AVdd supply, the output common-mode of the headphone driver is set by the common-mode setting of analog inputs in Page 1 / Register 10, Bit D6, to allow maximum utilization of the analog supply range while simultaneously providing a higher output-voltage swing. In cases when higher output-voltage swing is required, the headphone amplifiers can run directly from the higher supply voltage on LDOIN input (up to 3.6 V). To use the higher supply voltage for higher output signal swing, the output common-mode can be adjusted to either 1.25 V, 1.5 V or 1.65 V by configuring Page 1 / Register 10, Bits D5-D4. When the common-mode voltage is configured at 1.65 V and LDOIN supply is 3.3 V, the headphones can each deliver up to 40 mW power into a 16Ω load.

The headphone drivers are capable of driving a mixed combination of DAC signal and bypass from analog input INL and INR by configuring Page 1 / Register 12 and Page 1 / Register 13 respectively. The analog input signals can be attenuated up to 72dB before routing by configuring Page 1 / Register 22 and 23. The level of the DAC signal can be controlled using the digital volume control of the DAC in Page 0, Reg 65 and 66. To control the output-voltage swing of headphone drivers, the digital volume control provides a range of –6.0dB to +29.0dB(6) in steps of 1dB. These can be configured by programming Page 1 / Register 16 and 17. These level controls are not meant to be used as dynamic volume control, but more to set output levels during initial device configuration.

10.3.2.4 Line Outputs

The stereo line level drivers on LOL and LOR pins can drive a wide range of line level resistive impedances in the range of 600Ω to $10k\Omega$. The output common modes of line level drivers can be configured to equal either the analog input common-mode setting, or 1.65V. With output common-mode setting of 1.65V and DRVdd_HP supply at 3.3V the line-level drivers can drive up to 1Vrms output signal. The line-level drivers can drive out a mixed combination of DAC signal and attenuated ADC PGA signal. Signal mixing is register-programmable.



10.3.3 ADC

The PCM3070 includes a stereo audio ADC, which uses a delta-sigma modulator with a programmable oversampling ratio, followed by a digital decimation filter. The stereo recording path can be powered up one channel at a time, to support the case where only mono record capability is required.

The ADC path of the PCM3070 features a large set of options for signal conditioning as well as signal routing:

- Two ADCs
- · Six analog inputs which can be mixed and-or multiplexed in single-ended and-or differential configuration
- Two programmable gain amplifiers (PGA) with a range of 0 to +47.5dB
- · Two mixer amplifiers for analog bypass
- Two analog bypass channels
- Fine gain adjustment of digital channels with 0.1dB step size
- Digital volume control with a range of -12 to +20dB
- Mute function
- Automatic gain control (AGC)

In addition to the standard set of ADC features the PCM3070 also offers the following special functions:

- Channel-to-channel phase adjustment
- Fast charge of ac-coupling capacitors
- Anti thump
- Adaptive filter mode

10.3.3.1 ADC Processing

The PCM3070 offers a range of processing blocks which implement various signal processing capabilities along with decimation filtering. These processing blocks give users the choice of how much and what type of signal processing they may use and which decimation filter is applied.

10.3.3.1.1 ADC Processing Blocks

The PCM3070 offers a range of processing blocks which implement various signal processing capabilities along with decimation filtering. These processing blocks give users the choice of how much and what type of signal processing they may use and which decimation filter is applied.

Table 2 gives an overview of the available processing blocks and their properties.

The signal processing blocks available are:

- First-order IIR
- Scalable number of biquad filters
- Variable-tap FIR filter
- AGC

The processing blocks are tuned for common cases and can achieve high anti-alias filtering or low group delay in combination with various signal processing effects such as audio effects and frequency shaping. The available first order IIR, BiQuad and FIR filters have fully user-programmable coefficients. The Resource Class Column (RC) gives an approximate indication of power consumption.



Table 2. ADC Processing Blocks

Processing Blocks	Channel	Decimation Filter	1st Order IIR Available	Number BiQuads	FIR	Required AOSR Value	Resource Class
PRB_R1 ⁽¹⁾	Stereo	Α	Yes	0	No	128,64	6
PRB_R2	Stereo	Α	Yes	5	No	128,64	8
PRB_R3	Stereo	Α	Yes	0	25-Tap	128,64	8
PRB_R4	Right	Α	Yes	0	No	128,64	3
PRB_R5	Right	Α	Yes	5	No	128,64	4
PRB_R6	Right	Α	Yes	0	25-Tap	128,64	4
PRB_R7	Stereo	В	Yes	0	No	64	3
PRB_R8	Stereo	В	Yes	3	No	64	4
PRB_R9	Stereo	В	Yes	0	20-Tap	64	4
PRB_R10	Right	В	Yes	0	No	64	2
PRB_R11	Right	В	Yes	3	No	64	2
PRB_R12	Right	В	Yes	0	20-Tap	64	2
PRB_R13	Stereo	С	Yes	0	No	32	3
PRB_R14	Stereo	С	Yes	5	No	32	4
PRB_R15	Stereo	С	Yes	0	25-Tap	32	4
PRB_R16	Right	С	Yes	0	No	32	2
PRB_R17	Right	С	Yes	5	No	32	2
PRB_R18	Right	С	Yes	0	25-Tap	32	2

⁽¹⁾ Default

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.4 DAC

The PCM3070 includes a stereo audio DAC supporting data rates from 8kHz to 192kHz. Each channel of the stereo audio DAC consists of a signal-processing engine with fixed processing blocks, a programmable miniDSP, a digital interpolation filter, multi-bit digital delta-sigma modulator, and an analog reconstruction filter. The DAC is designed to provide enhanced performance at low sampling rates through increased oversampling and image filtering, thereby keeping quantization noise generated within the delta-sigma modulator and signal images strongly suppressed within the audio band to beyond 20kHz. To handle multiple input rates and optimize performance, the PCM3070 allows the system designer to program the oversampling rates over a wide range from 1 to 1024. The system designer can choose higher oversampling ratios for lower input data rates and lower oversampling ratios for higher input data rates.

The PCM3070 DAC channel includes a built-in digital interpolation filter to generate oversampled data for the sigma-delta modulator. The interpolation filter can be chosen from three different types depending on required frequency response, group delay and sampling rate.

The DAC path of the PCM3070 features many options for signal conditioning and signal routing:

- · 2 headphone amplifiers
 - Usable in single-ended or differential mode
 - Analog volume setting with a range of -6 to +29dB
- 2 line-out amplifiers
 - Usable in single-ended or differential mode
 - Analog volume setting with a range of -6 to +29dB
- Digital volume control with a range of -63.5 to +24dB
- Mute function
- Dynamic range compression (DRC)



In addition to the standard set of DAC features the PCM3070 also offers the following special features:

- Built in sine wave generation (beep generator)
- · Digital auto mute
- Adaptive filter mode

10.3.4.1 DAC Processing Blocks — Overview

The PCM3070 implements signal processing capabilities and interpolation filtering via processing blocks. These fixed processing blocks give users the choice of how much and what type of signal processing they may use and which interpolation filter is applied.

Table 3 gives an overview over all available processing blocks of the DAC channel and their properties. The Resource Class Column (RC) gives an approximate indication of power consumption.

The signal processing blocks available are:

- First-order IIR
- · Scalable number of biquad filters
- 3D Effect
- Beep Generator

The processing blocks are tuned for typical cases and can achieve high image rejection or low group delay in combination with various signal processing effects such as audio effects and frequency shaping. The available first-order IIR and biquad filters have fully user-programmable coefficients. The Resource Class Column (RC) gives an approximate indication of power consumption.

Table 3. Overview - DAC Predefined Processing Blocks

Processing Block No.	Interpolation Filter	Channel	1st Order IIR Available	Num. of Biquads	DRC	3D	Beep Generator
PRB_P1 ⁽¹⁾	A	Stereo	No	3	No	No	No
PRB_P2	А	Stereo	Yes	6	Yes	No	No
PRB_P3	А	Stereo	Yes	6	No	No	No
PRB_P4	A	Left	No	3	No	No	No
PRB_P5	A	Left	Yes	6	Yes	No	No
PRB_P6	А	Left	Yes	6	No	No	No
PRB_P7	В	Stereo	Yes	0	No	No	No
PRB_P8	В	Stereo	No	4	Yes	No	No
PRB_P9	В	Stereo	No	4	No	No	No
PRB_P10	В	Stereo	Yes	6	Yes	No	No
PRB_P11	В	Stereo	Yes	6	No	No	No
PRB_P12	В	Left	Yes	0	No	No	No
PRB_P13	В	Left	No	4	Yes	No	No
PRB_P14	В	Left	No	4	No	No	No
PRB_P15	В	Left	Yes	6	Yes	No	No
PRB_P16	В	Left	Yes	6	No	No	No
PRB_P17	С	Stereo	Yes	0	No	No	No
PRB_P18	С	Stereo	Yes	4	Yes	No	No
PRB_P19	С	Stereo	Yes	4	No	No	No
PRB_P20	С	Left	Yes	0	No	No	No
PRB_P21	С	Left	Yes	4	Yes	No	No
PRB_P22	С	Left	Yes	4	No	No	No
PRB_P23	А	Stereo	No	2	No	Yes	No
PRB_P24	А	Stereo	Yes	5	Yes	Yes	No
PRB_P25	А	Stereo	Yes	5	Yes	Yes	Yes

(1) Default

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For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.5 Digital Audio IO Interface

Audio data is transferred between the host processor and the PCM3070 via the digital audio data serial interface, or audio bus. The audio bus on this device is very flexible, including left or right-justified data options, support for I2S or PCM protocols, programmable data length options, a TDM mode for multichannel operation, very flexible master/slave configurability for each bus clock line, and the ability to communicate with multiple devices within a system directly.

The audio bus of the PCM3070 can be configured for left or right-justified, I2S, DSP, or TDM modes of operation, where communication with standard PCM interfaces is supported within the TDM mode. These modes are all MSB-first, with data width programmable as 16, 20, 24, or 32 bits by configuring Page 0, Register 27, D(5:4). In addition, the word clock and bit clock can be independently configured in either Master or Slave mode, for flexible connectivity to a wide variety of processors. The word clock is used to define the beginning of a frame, and may be programmed as either a pulse or a square-wave signal. The frequency of this clock corresponds to the maximum of the selected ADC and DAC sampling frequencies.

The bit clock is used to clock in and clock out the digital audio data across the serial bus. When in Master mode, this signal can be programmed to generate variable clock pulses by controlling the bit-clock divider in Page 0, Register 30. The number of bit-clock pulses in a frame may need adjustment to accommodate various word-lengths as well as to support the case when multiple PCM3070s may share the same audio bus.

The PCM3070 also includes a feature to offset the position of start of data transfer with respect to the word-clock. This offset can be controlled in terms of number of bit-clocks and can be programmed in Page 0, Register 28.

The PCM3070 also has the feature of inverting the polarity of the bit-clock used for transferring the audio data as compared to the default clock polarity used. This feature can be used independently of the mode of audio interface chosen. This can be configured via Page 0, Register 29, D(3).

The PCM3070 further includes programmability (Page 0, Register 27, D0) to place the DOUT line into a hi-Z (3-state) condition during all bit clocks when valid data is not being sent. By combining this capability with the ability to program at what bit clock in a frame the audio data begins, time-division multiplexing (TDM) can be accomplished, enabling the use of multiple codecs on a single audio serial data bus. When the audio serial data bus is powered down while configured in master mode, the pins associated with the interface are put into a hi-Z output condition.

By default when the word-clocks and bit-clocks are generated by the PCM3070, these clocks are active only when the codec (ADC, DAC or both) are powered up within the device. This is done to save power. However, it also supports a feature when both the word clocks and bit-clocks can be active even when the codec in the device is powered down. This is useful when using the TDM mode with multiple codecs on the same bus, or when word-clock or bit-clocks are used in the system as general-purpose clocks.

10.3.6 Clock Generation and PLL

The PCM3070 supports a wide range of options for generating clocks for the ADC and DAC sections as well as interface and other control blocks. The clocks for ADC and DAC require a source reference clock. This clock can be provided on variety of device pins such as MCLK, BCLK or GPI pins. The CODEC_CLKIN can then be routed through highly-flexible clock dividers to generate the various clocks required for ADC, DAC and the miniDSP sections. In the event that the desired audio or miniDSP clocks cannot be generated from the reference clocks on MCLK BCLK or GPIO, the PCM3070 also provides the option of using the on-chip PLL which supports a wide range of fractional multiplication values to generate the required clocks. Starting from CODEC_CLKIN the PCM3070 provides several programmable clock dividers to help achieve a variety of sampling rates for ADC, DAC and clocks for the miniDSP.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.3.7 Control Interfaces

The PCM3070 control interface supports SPI or I²C communication protocols, with the protocol selectable using the SPI_SELECT pin. For SPI, SPI_SELECT should be tied high; for I²C, SPI_SELECT should be tied low. Changing the state of SPI_SELECT during device operation is not recommended.



10.3.7.1 PC Control

The PCM3070 supports the I²C control protocol, and will respond to the I²C address of 0011000. I²C is a two-wire, open-drain interface supporting multiple devices and masters on a single bus. Devices on the I²C bus only drive the bus lines LOW by connecting them to ground; they never drive the bus lines HIGH. Instead, the bus wires are pulled HIGH by pullup resistors, so the bus wires are HIGH when no device is driving them LOW. This circuit prevents two devices from conflicting; if two devices drive the bus simultaneously, there is no driver contention.

10.3.7.2 SPI Control

In the SPI control mode, the PCM3070 uses the pins SCL/SS as SS, SCLK as SCLK, MISO as MISO, SDA/MOSI as MOSI; a standard SPI port with clock polarity setting of 0 (typical microprocessor SPI control bit CPOL = 0). The SPI port allows full-duplex, synchronous, serial communication between a host processor (the master) and peripheral devices (slaves). The SPI master (in this case, the host processor) generates the synchronizing clock (driven onto SCLK) and initiates transmissions. The SPI slave devices (such as the PCM3070) depend on a master to start and synchronize transmissions. A transmission begins when initiated by an SPI master. The byte from the SPI master begins shifting in on the slave MOSI pin under the control of the master serial clock (driven onto SCLK). As the byte shifts in on the MOSI pin, a byte shifts out on the MISO pin to the master shift register.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.4 Device Functional Modes

The following special functions are available to support advanced system requirements:

- Interrupt generation
- Flexible pin multiplexing

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

10.4.1 MiniDSP

The PCM3070 features two miniDSP cores. The first miniDSP core is tightly coupled to the ADC, the second miniDSP core is tightly coupled to the DAC. The fully programmable algorithms for the miniDSP must be loaded into the device after power up. The miniDSPs have direct access to the digital stereo audio stream on the ADC and on the DAC side, offering the possibility for advanced, very-low group delay DSP algorithms. Each miniDSP can run up to 1152 instructions on every audio sample at a 48kHz sample rate. The two cores can run fully synchronized and can exchange data.

10.4.2 Software

Software development for the PCM3070 is supported through TI's comprehensive PurePath Studio Development Environment; a powerful, easy-to-use tool designed specifically to simplify software development on the PCM3070 miniDSP audio platform. The Graphical Development Environment consists of a library of common audio functions that can be dragged-and-dropped into an audio signal flow and graphically connected together. The DSP code can then be assembled from the graphical signal flow with the click of a mouse.

Please visit the PCM3070 product folder on www.ti.com to learn more about PurePath Studio and the latest status on available, ready-to-use DSP algorithms.



10.5 Register Map

10.5.1 Register Map Summary

Table 4. Summary of Register Map

Decimal		Hex		DESCRIPTION		
PAGE NO.	REG. NO.	PAGE NO.	REG. NO.			
0	0	0x00	0x00	Page Select Register		
0	1	0x00	0x01	Software Reset Register		
0	2	0x00	0x02	Reserved Register		
0	3	0x00	0x03	Reserved Register		
0	4	0x00	0x04	Clock Setting Register 1, Multiplexers		
0	5	0x00	0x05	Clock Setting Register 2, PLL P&R Values		
0	6	0x00	0x06	Clock Setting Register 3, PLL J Values		
0	7	0x00	0x07	Clock Setting Register 4, PLL D Values (MSB)		
0	8	0x00	0x08	Clock Setting Register 5, PLL D Values (LSB)		
0	9-10	0x00	0x09-0x0A	Reserved Register		
0	11	0x00	0x0B	Clock Setting Register 6, NDAC Values		
0	12	0x00	0x0C	Clock Setting Register 7, MDAC Values		
0	13	0x00	0x0D	DAC OSR Setting Register 1, MSB Value		
0	14	0x00	0x0E	DAC OSR Setting Register 2, LSB Value		
0	15	0x00	0x0F	miniDSP_D Instruction Control Register 1		
0	16	0x00	0x10	miniDSP_D Instruction Control Register 2		
0	17	0x00	0x11	miniDSP_D Interpolation Factor Setting Register		
0	18	0x00	0x12	Clock Setting Register 8, NADC Values		
0	19	0x00	0x13	Clock Setting Register 9, MADC Values		
0	20	0x00	0x14	ADC Oversampling (AOSR) Register		
0	21	0x00	0x15	miniDSP_A Instruction Control Register 1		
0	22	0x00	0x16	miniDSP_A Instruction Control Register 2		
0	23	0x00	0x17	miniDSP_A Decimation Factor Setting Register		
0	24	0x00	0x18	Reserved Register		
0	25	0x00	0x19	Clock Setting Register 10, Multiplexers		
0	26	0x00	0x1A	Clock Setting Register 11, CLKOUT M divider value		
0	27	0x00	0x1B	Audio Interface Setting Register 1		
0	28	0x00	0x1C	Audio Interface Setting Register 2, Data offset setting		
0	29	0x00	0x1D	Audio Interface Setting Register 3		
0	30	0x00	0x1E	Clock Setting Register 12, BCLK N Divider		
0	31	0x00	0x1F	Audio Interface Setting Register 4, Secondary Audio Interface		
0	32	0x00	0x20	Audio Interface Setting Register 5		
0	33	0x00	0x21	Audio Interface Setting Register 6		
0	34	0x00	0x22	Digital Interface Misc. Setting Register		
0	35	0x00	0x23	Reserved Register		
0	36	0x00	0x24	ADC Flag Register		
0	37	0x00	0x25	DAC Flag Register 1		
0	38	0x00	0x26	DAC Flag Register 2		
0	39-41	0x00	0x27-0x29	Reserved Register		
0	42	0x00	0x2A	Sticky Flag Register 1		
0	43	0x00	0x2B	Interrupt Flag Register 1		
0	44	0x00	0x2C	Sticky Flag Register 2		
0	45	0x00	0x2D	Sticky Flag Register 3		



Register Map (continued)

Table 4. Summary of Register Map (continued)

			DESCRIPTION	
PAGE NO. REG. NO.				DESCRIPTION
0	REG. NO.	PAGE NO.	REG. NO.	Interrupt Flog Pogistor 2
-	47	0x00	0x2E 0x2F	Interrupt Flag Register 2
0	48	0x00		Interrupt Flag Register 3 INT1 Interrupt Control Register
-			0x30	
0	49	0x00	0x31	INT2 Interrupt Control Register
0	50-51	0x00	0x32-0x33	Reserved Register
0	52	0x00	0x34	GPIO/MFP5 Control Register
0	53	0x00	0x35	DOUT/MFP2 Function Control Register
0	54	0x00	0x36	DIN/MFP1 Function Control Register
0	55	0x00	0x37	MISO/MFP4 Function Control Register
0	56	0x00	0x38	SCLK/MFP3 Function Control Register
0	57-59	0x00	0x39-0x3B	Reserved Registers
0	60	0x00	0x3C	DAC Signal Processing Block Control Register
0	61	0x00	0x3D	ADC Signal Processing Block Control Register
0	62	0x00	0x3E	miniDSP_A and miniDSP_D Configuration Register
0	63	0x00	0x3F	DAC Channel Setup Register 1
0	64	0x00	0x40	DAC Channel Setup Register 2
0	65	0x00	0x41	Left DAC Channel Digital Volume Control Register
0	66	0x00	0x42	Right DAC Channel Digital Volume Control Register
0	67	0x00	0x43	Headset Detection Configuration Register
0	68	0x00	0x44	DRC Control Register 1
0	69	0x00	0x45	DRC Control Register 2
0	70	0x00	0x46	DRC Control Register 3
0	71	0x00	0x47	Beep Generator Register 1
0	72	0x00	0x48	Beep Generator Register 2
0	73	0x00	0x49	Beep Generator Register 3
0	74	0x00	0x4A	Beep Generator Register 4
0	75	0x00	0x4B	Beep Generator Register 5
0	76	0x00	0x4C	Beep Generator Register 6
0	77	0x00	0x4D	Beep Generator Register 7
0	78	0x00	0x4E	Beep Generator Register 8
0	79	0x00	0x4F	Beep Generator Register 9
0	80	0x00	0x50	Reserved Register
0	81	0x00	0x51	ADC Channel Setup Register
0	82	0x00	0x52	ADC Fine Gain Adjust Register
0	83	0x00	0x53	Left ADC Channel Volume Control Register
0	84	0x00	0x54	Right ADC Channel Volume Control Register
0	85	0x00	0x55	ADC Phase Adjust Register
0	86	0x00	0x56	Left Channel AGC Control Register 1
0	87	0x00	0x57	Left Channel AGC Control Register 2
0	88	0x00	0x58	Left Channel AGC Control Register 3
0	89	0x00	0x59	Left Channel AGC Control Register 4
0	90	0x00	0x5A	Left Channel AGC Control Register 5
0	91	0x00	0x5B	Left Channel AGC Control Register 6
0	92	0x00	0x5C	Left Channel AGC Control Register 7
0	93	0x00	0x5D	Left Channel AGC Control Register 8



Register Map (continued)

Table 4. Summary of Register Map (continued)

PAGE NO. PAGE NO. PAGE NO. Ox5E Right Channel AGC Control Register 1	Decimal		н	ex	DESCRIPTION
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1 51 0x01 0x33 Reserved. Do Not Use 1 52 0x01 0x34 Left PGA Positive Terminal Input Routing Configuration Register	1	26-50	0x01	0x1A-0x32	
	1	51	0x01	0x33	
	1	52	0x01	0x34	Left PGA Positive Terminal Input Routing Configuration Register
. The state of the	1	53	0x01	0x35	Reserved Register
1 54 0x01 0x36 Left PGA Negative Terminal Input Routing Configuration Register	1		0x01	0x36	



Register Map (continued)

Table 4. Summary of Register Map (continued)

Decimal		Н	ex	DESCRIPTION		
PAGE NO. REG. NO.		PAGE NO. REG. NO.				
1	55	0x01	0x37	Right PGA Positive Terminal Input Routing Configuration Register		
1	56	0x01	0x38	Reserved Register		
1	57	0x01	0x39	Right PGA Negative Terminal Input Routing Configuration Register		
1	58	0x01	0x3A	Floating Input Configuration Register		
1	59	0x01	0x3B	Left PGA Volume Control Register		
1	60	0x01	0x3C	Right PGA Volume Control Register		
1	61	0x01	0x3D	Reserved. Do Not Use		
1	62	0x01	0x3E	ADC Analog Volume Control Flag Register		
1	63	0x01	0x3F	DAC Analog Gain Control Flag Register		
1	64-70	0x01	0x40-0x46	Reserved Register		
1	71	0x01	0x47	Analog Input Quick Charging Configuration Register		
1	72-122	0x01	0x48-0x7A	Reserved Register		
1	123	0x01	0x7B	Reference Power-up Configuration Register		
1	124-127	0x01	0x7C-0x7F	Reserved Register		
8	0	0x08	0x00	Page Select Register		
8	1	0x08	0x01	ADC Adaptive Filter Configuration Register		
8	2-7	0x08	0x02-0x07	Reserved		
8	8-127	0x08	0x08-0x7F	ADC Coefficients Buffer-A C(0:29)		
9-16	0	0x09-0x10	0x00	Page Select Register		
9-16	1-7	0x09-0x10	0x01-0x07	Reserved		
9-16	8-127	0x09-0x10	0x08-0x7F	ADC Coefficients Buffer-A C(30:255)		
26-34	0	0x1A-0x22	0x00	Page Select Register		
26-34	1-7	0x1A-0x22	0x01-0x07	Reserved.		
26-34	8-127	0x1A-0x22	0x08-0x7F	ADC Coefficients Buffer-B C(0:255)		
44	0	0x2C	0x00	Page Select Register		
44	1	0x2C	0x01	DAC Adaptive Filter Configuration Register		
44	2-7	0x2C	0x02-0x07	Reserved		
44	8-127	0x2C	0x08-0x7F	DAC Coefficients Buffer-A C(0:29)		
45-52	0	0x2D-0x34	0x00	Page Select Register		
45-52	1-7	0x2D-0x34	0x01-0x07	Reserved.		
45-52	8-127	0x2D-0x34	0x08-0x7F	DAC Coefficients Buffer-A C(30:255)		
62-70	0	0x3E-0x46	0x00	Page Select Register		
62-70	1-7	0x3E-0x46	0x01-0x07	Reserved.		
62-70	8-127	0x3E-0x46	0x08-0x7F	DAC Coefficients Buffer-B C(0:255)		
80-114	0	0x50-0x72	0x00	Page Select Register		
80-114	1-7	0x50-0x72	0x01-0x07	Reserved.		
80-114	8-127	0x50-0x72	0x08-0x7F	miniDSP_A Instructions		
152-186	0	0x98-0xBA	0x00	Page Select Register		
152-186	1-7	0x98-0xBA	0x01-0x07	Reserved.		
152-186	8-127	0x98-0xBA	0x08-0x7F	miniDSP_D Instructions		



11 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

11.1 Application Information

The PCM3070 is a highly integrated stereo audio codec with integrated miniDSP and flexible digital audio interface options. It enables many different types of audio platforms having a need for stereo audio record and playback and needing to interface with other devices in the system over a digital audio interface.

11.2 Typical Application

Figure 19 shows a typical circuit configuration for a system using the PCM3070.

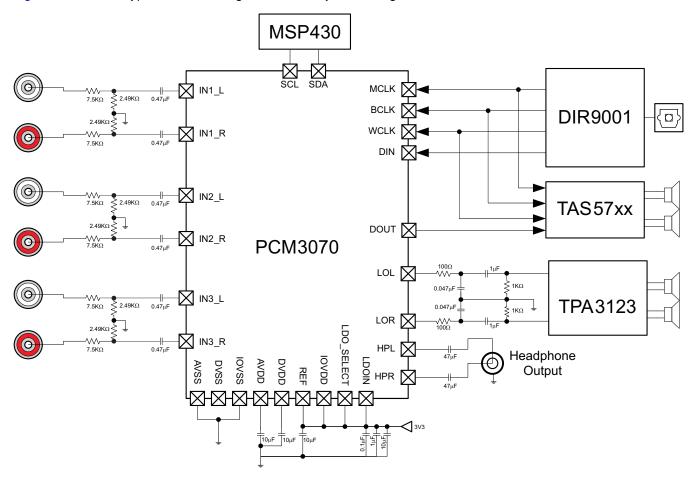


Figure 19. Typical Circuit Configuration



Typical Application (continued)

11.2.1 Design Requirements

11.2.1.1 Reference Filtering Capacitor

The PCM3070 has a built-in bandgap used to generate reference voltages and currents for the device. To achieve high SNR, the reference voltage on REF should be filtered using a 10-µF capacitor from REF terminal to ground.

11.2.2 Detailed Design Procedures

11.2.2.1 Analog Input Connection

The analog inputs to PCM3070 should be ac-coupled to the device terminals to allow decoupling of signal source's common mode voltage with that of PCM3070's common mode voltage. The input coupling capacitor in combination with the selected input impedance of PCM3070 forms a high-pass filter.

$$F_c = 1/(2 \times \pi \times R_{e0}C_c)$$
 (1)

$$C_c = 1/(2 \times \pi \times R_{eq} F_c)$$
 (2)

For high fidelity audio recording application it is desirable to keep the cutoff frequency of the high pass filter as low as possible. For single-ended input mode, the equivalent input resistance R_{eq} can be calculated as

$$R_{eq} = R_{in} \times (1 + 2g)/(1+g) \tag{3}$$

where g is the analog PGA gain calculated in linear terms.

$$q = 10000 \times 2^{floor(G/6)}/R_{in}$$
(4)

where G is the analog PGA gain programmed in P1_R59-R60 (in dB) and R_{in} is the value of the resistor programmed in P1_R52-R57 and assumes $R_{in} = R_{cm}$ (as defined in P1_R52-R57).

For differential input mode, R_{eq} of the half circuit can be calculated as:

$$R_{eq} = R_{in} \tag{5}$$

where R_{in} is the value of the resistor programmed in P1_R52-R57, assuming symmetrical inputs.

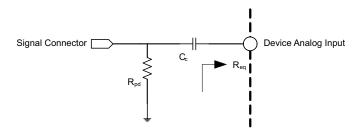


Figure 20. Analog Input Connection With Pull-down Resistor

When the analog signal is connected to the system through a connector such as audio jack, it is recommended to put a pull-down resistor on the signal as shown in Figure 20. The pulldown resistor helps keep the signal grounded and helps improve noise immunity when no source is connected to the connector. The pulldown resistor value should be chosen large enough to avoid loading of signal source.

Each analog input of the PCM3070 is capable of handling signal amplitude of 0.5 Vrms. If the input signal source can drive signals higher than the maximum value, an external resistor divider network as shown in Figure 21 should be used to attenuate the signal to less than 0.5Vrms before connecting the signal to the device. The resistor values of the network should be chosen to provide desired attenuation as well as Equation 6.

$$R_1 || R_2 << R_{eq} \tag{6}$$



Typical Application (continued)

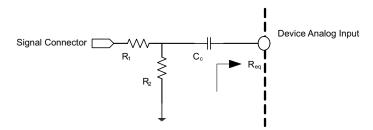


Figure 21. Analog Input Connection With Resistor Divider Network

Whenever any of the analog input terminals IN1_L, IN2_L, IN3_L, IN1_R, IN2_R or IN3_R are not used in an application, it is recommended to short the unused input terminals together (if convenient) and connect them to ground using a small capacitor (example $0.1 \mu F$).

11.2.2.2 Analog Output Connection

The line outputs of the PCM3070 drive a signal biased around the device common mode voltage. To avoid loading the common mode with the load, it is recommended to connect the single-ended load through an accoupling capacitor. The ac-coupling capacitor in combination with the load impedance forms a high pass filter.

$$F_{c} = 1/(2 \times \pi \times R_{L}C_{c}) \tag{7}$$

 $C_c = 1/(2 \times \pi \times R_L F_c)$ (8)

For high fidelity playback, the cutoff frequency of the resultant high-pass filter should be kept low. For example with R_L of 10 k Ω , using 1- μ F coupling capacitor results in a cut-off frequency of 8 Hz.

For differential lineout configurations, the load should be directly connected between the differential outputs, with no coupling capacitor.

Whenever any of the analog output terminals LOL, LOR, HPL or HPR are not used in an application, they should be left open or not connected.



Typical Application (continued)

11.2.3 Application Curves

Figure 22 shows the excellent low-distortion performance of the PCM3070 in a system over the 20-Hz to 20-kHz audio spectrum.

Figure 23 shows the distortion performance of the PCM3070 in a system over the input amplitude range.

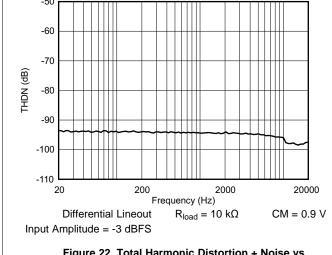


Figure 22. Total Harmonic Distortion + Noise vs Input Frequency

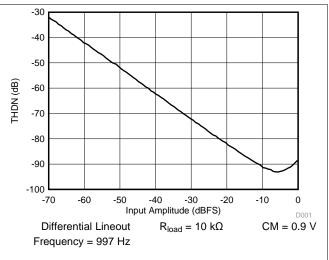


Figure 23. Total Harmonic Distortion + Noise vs Input Amplitude

iomit Documentation Feedback



12 Power Supply Recommendations

To power up the device, a 3.3V system rail (1.9V to 3.6V) can be used. The IOVDD voltage can be in the range of 1.1V - 3.6V. Internal LDOs can generate the appropriate digital and analog core voltages when configured to do so. For maximum flexibility, the respective voltages can also be supplied externally, bypassing the built-in LDOs. To support high-output drive capabilities, the output stages of the output amplifiers can be driven from the analog core voltage or the 1.9...3.6V rail used for the LDO inputs (LDO_in).

The AVDD and LDOIN power inputs are used to power the analog circuits including analog to digital converters, digital to analog converters, programmable gain amplifiers, headphone amplifiers, etc. The analog blocks in PCM3070 have high power supply rejection ratio, however it is recommended that these supplies be powered by well regulated power supplies like low dropout regulators (LDO) for optimal performance. When these power terminals are driven from a common power source, the current drawn from the source will depend upon blocks enabled inside the device. However as an example when all the internal blocks powered are enabled the source should be able to deliver 150mA of current.

The DVDD powers the digital core of PCM3070, including the miniDSP, the audio serial interface, control interfaces (SPI or I2C), clock generation and PLL. The DVDD power can be driven by high efficiency switching regulators or low drop out regulators. When the miniDSP_A and miniDSP_D are enabled in programmable mode and operated at peak frequencies, the supply source should be able to able to deliver approx 100mA of current. When the PRB modes are used instead of programmable miniDSP mode, then the peak current load on DVDD supply source could be approximately 20 mA.

The IOVDD powers the digital input and digital output buffers of PCM3070. The current consumption of this power depends on configuration of digital terminals as inputs or outputs. When the digital terminals are configured as outputs, the current consumption would depend on switching frequency of the signal and the load on the output terminal, which depends on board design and input capacitance of other devices connected to the signal.

Refer to Figure 19 for recommendations on decoupling capacitors.

For more detailed information see the PCM3070 Application Reference Guide, SLAU332.

13 Layout

13.1 Layout Guidelines

Each system design and PCB layout is unique. The layout should be carefully reviewed in the context of a specific PCB design. However, the following guidelines can optimize PCM3070 performance:

- Connect the thermal pad to ground.
- The decoupling capacitors for the power supplies should be placed close to the device terminals. Figure 19 shows the recommended decoupling capacitors for the PCM3070.
- The PCM3070 internal voltage references must be filtered using external capacitors. Place the filter capacitors on REF near the device terminals for optimal performance.
- For analog differential audio signals, the signals should be routed differentially on the PCB for better noise immunity. Avoid crossing of digital and analog signals to avoid undesirable crosstalk.



13.2 Layout Example

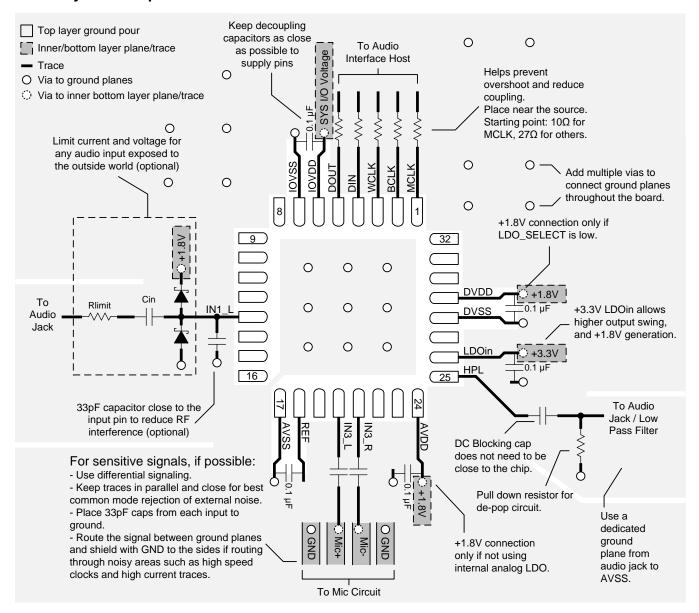


Figure 24. Layout

Product Folder Links: PCM3070

Example layout views can be found in the EVM User Guide:

http://www.ti.com/tool/PCM3070RHBEVM-K

Submit Documentation Feedback



14 Device and Documentation Support

14.1 Documentation Support

14.1.1 Related Documentation

PCM3070 Application Reference Guide, SLAU332.

14.2 Trademarks

All trademarks are the property of their respective owners.

14.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

14.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

15 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGE OPTION ADDENDUM

3-Oct-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	_	Pins	_	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PCM3070IRHBR	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PCM3070 I	Samples
PCM3070IRHBT	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		PCM3070 I	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

3-Oct-2014

n no event shall TI's liabili	tv arising out of such information	exceed the total purchase	price of the TI part(s) at issue in this document sold by	y TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 3-Oct-2014

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PCM3070IRHBR	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
PCM3070IRHBT	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
PCM3070IRHBR	VQFN	RHB	32	3000	367.0	367.0	35.0	
PCM3070IRHBT	VQFN	RHB	32	250	210.0	185.0	35.0	

5 x 5, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD



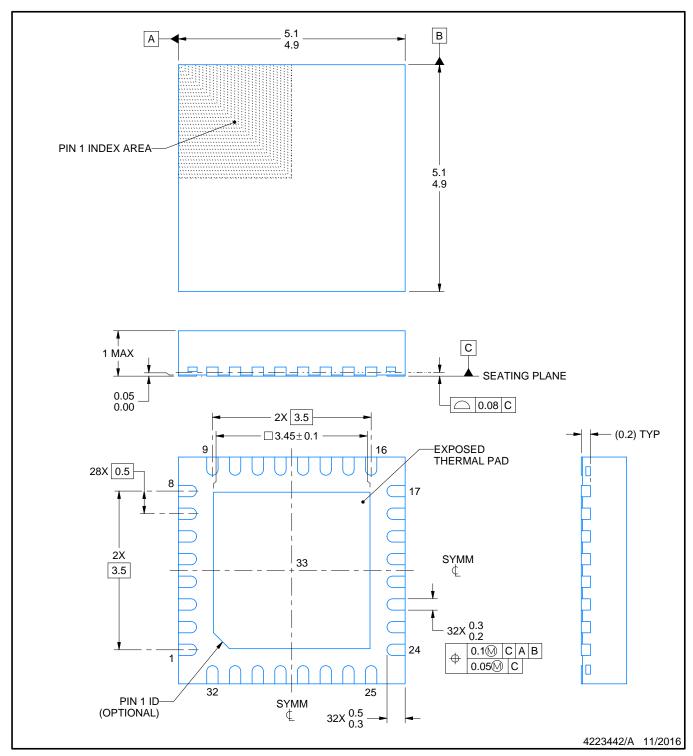
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4224745/A





PLASTIC QUAD FLATPACK - NO LEAD

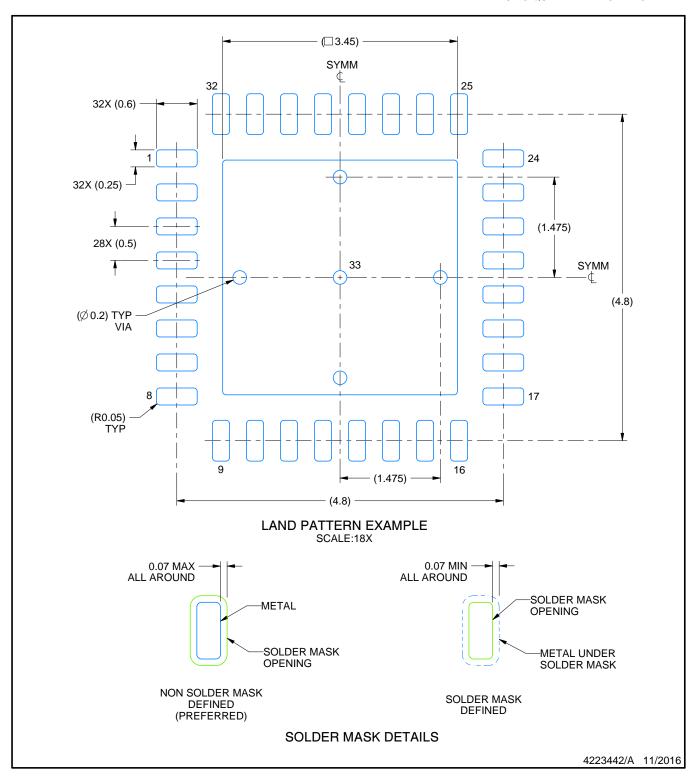


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

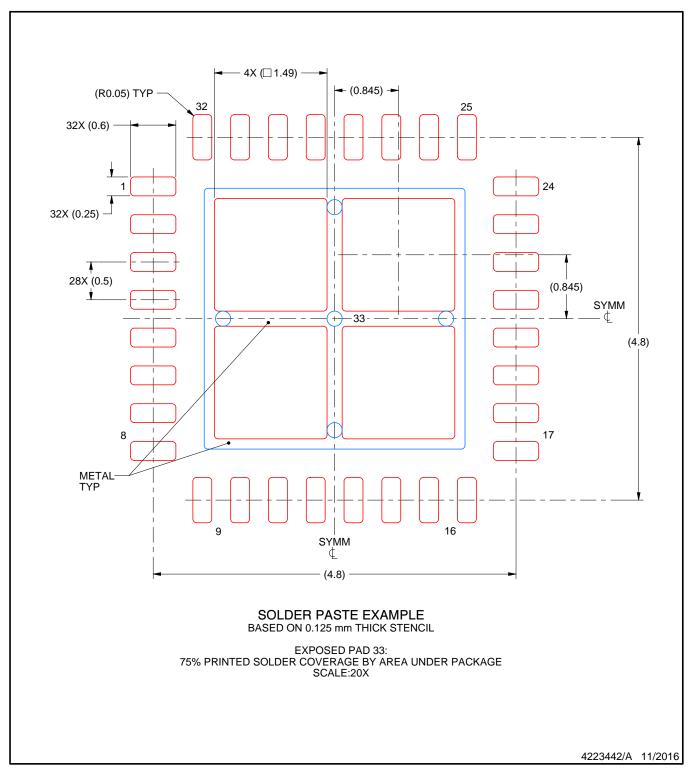


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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